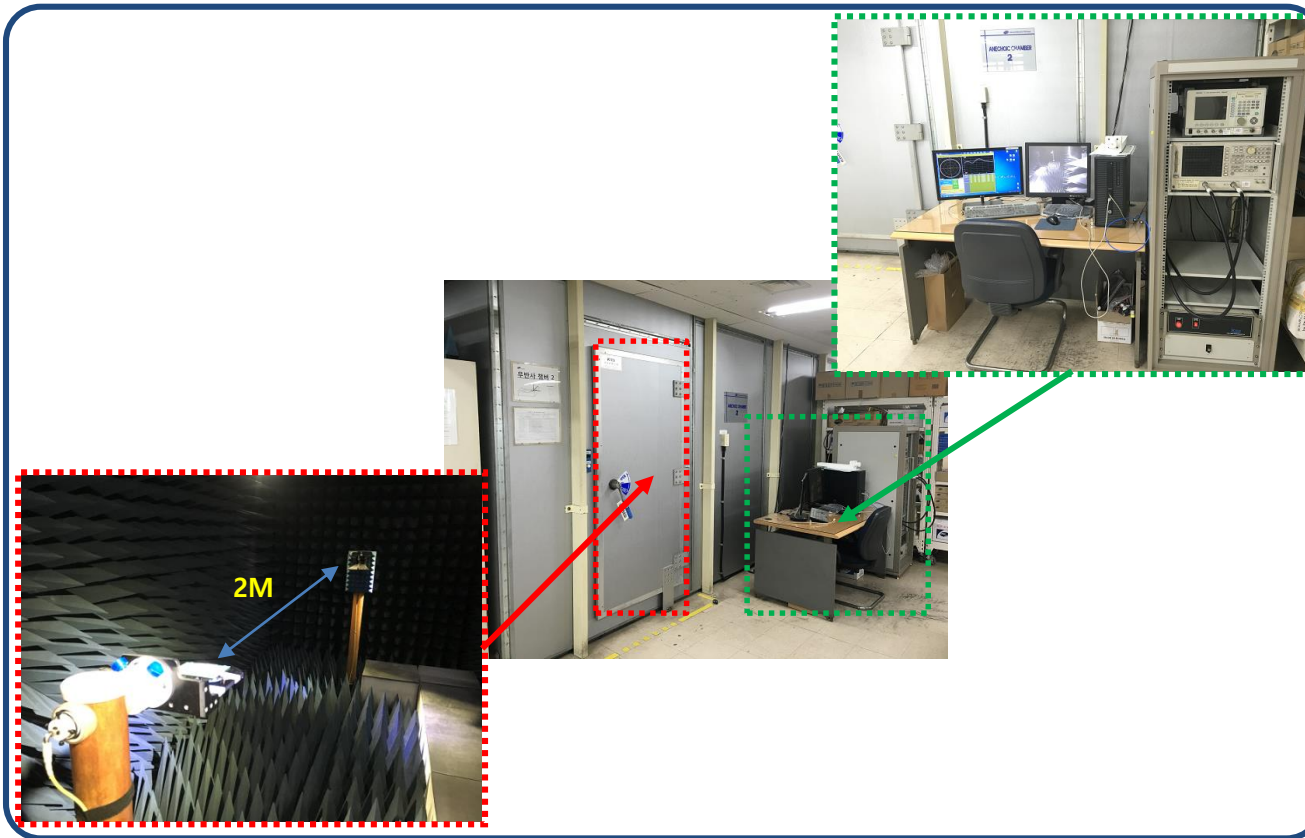
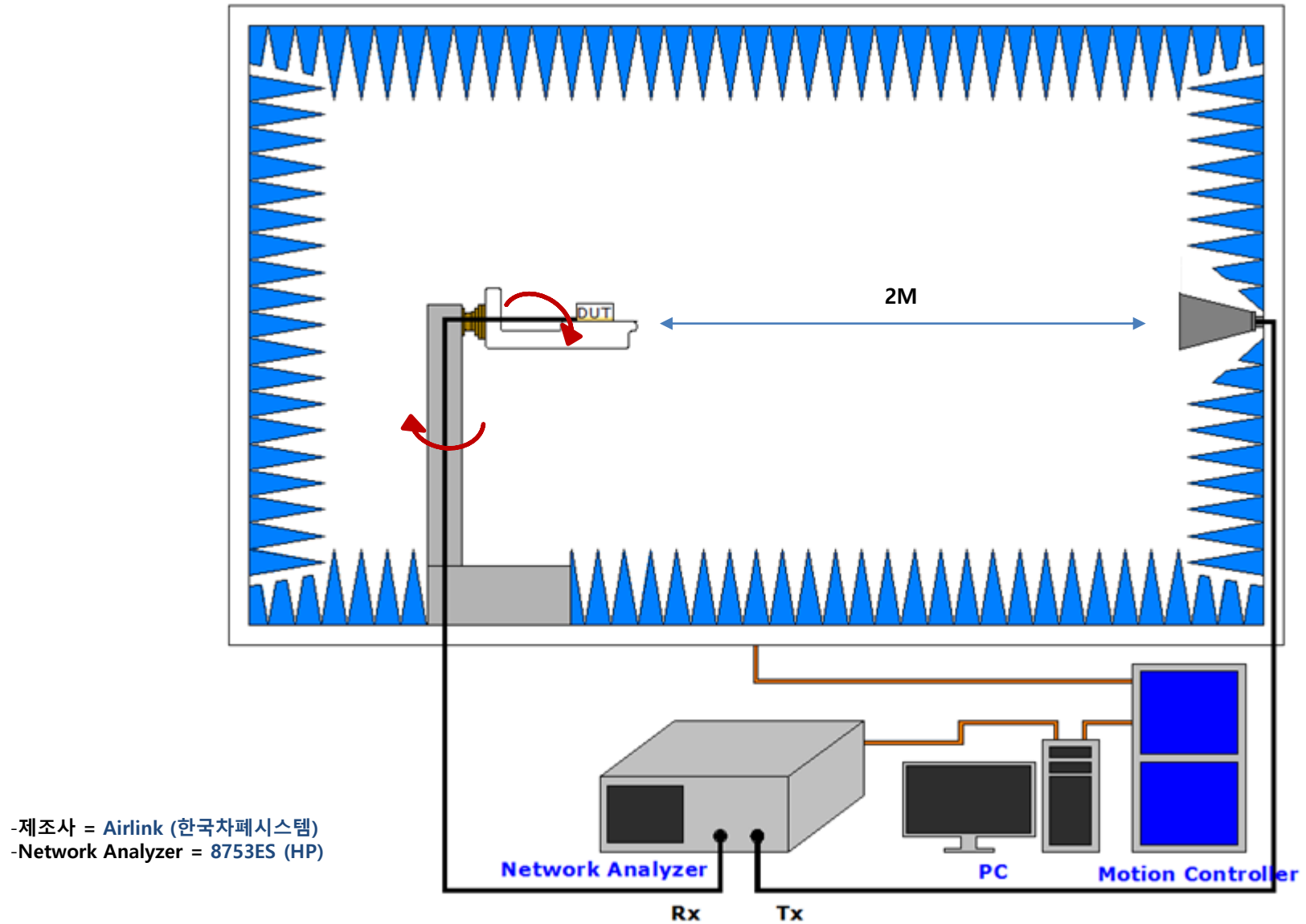




8753ES

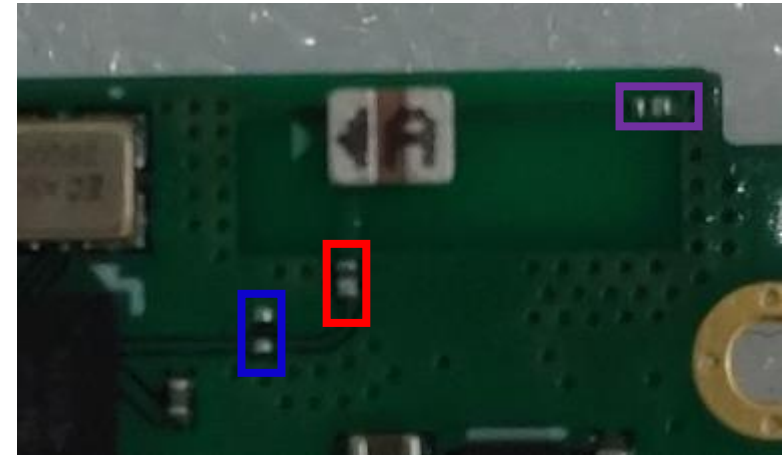
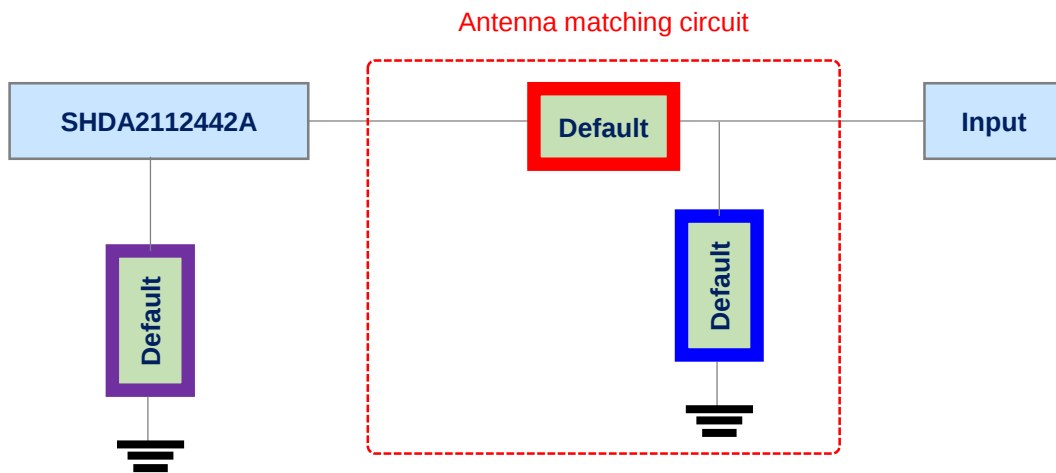
No	Equipment	Maker	MODEL
1	Anechoic Chamber	한국차페시스템	8*4*4
2	Network Analyzer	Agilent	8753ES

- S-parameter Measurement
- Antenna Gain Measurement



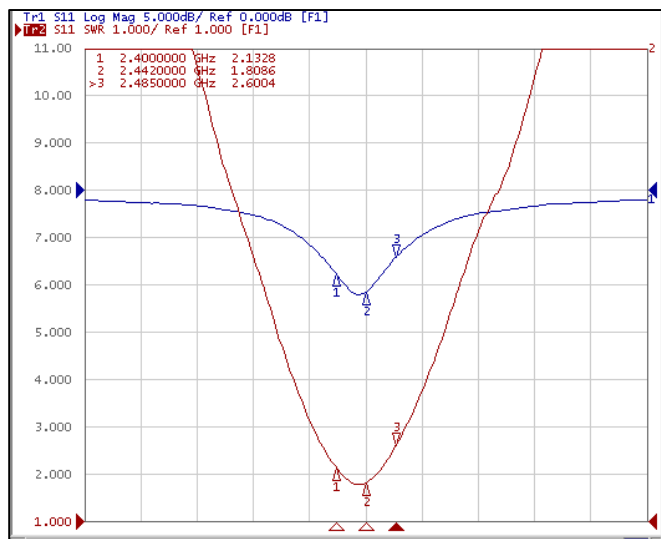
1. Measurement Report – Default Air condition

1-1. Antenna matching value



Set condition

1-2. Measured S-parameter

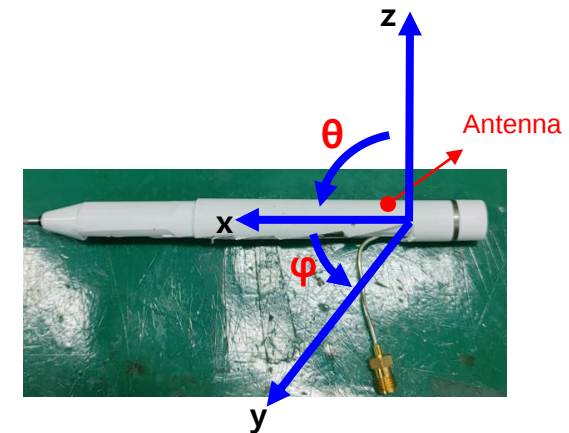


Return Loss & VSWR

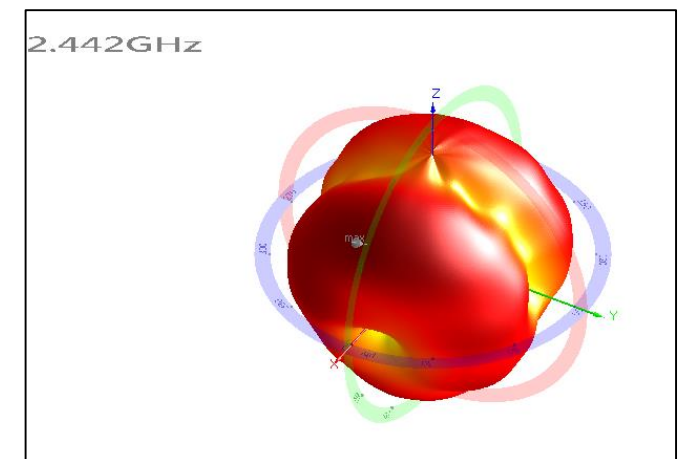
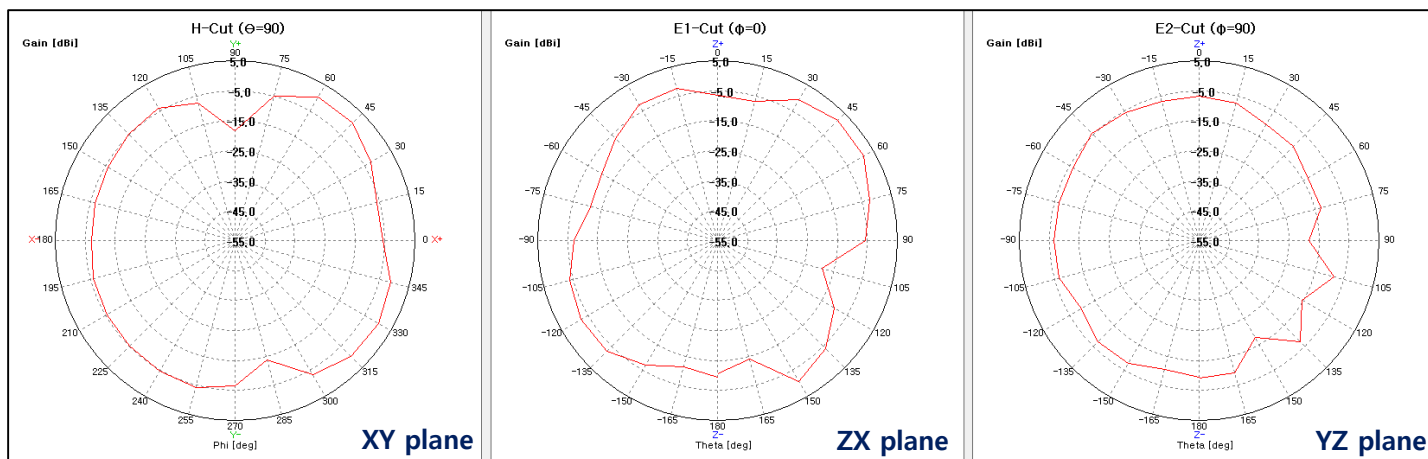
1. Measurement Report – Default Air condition

1-3. Antenna gain

Frequency [MHz]	Efficiency [%]	Average gain [dBi]	Peak gain [dBi]
2400	39.82	-4.00	1.58
2442	50.21	-2.99	2.70
2485	35.92	-4.45	1.21

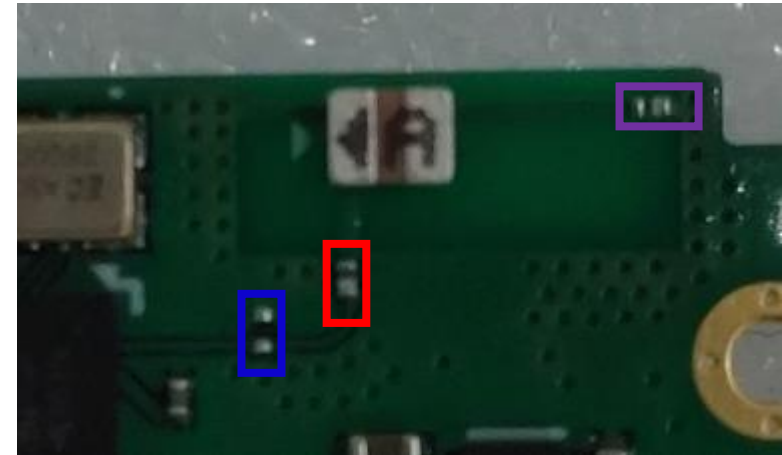
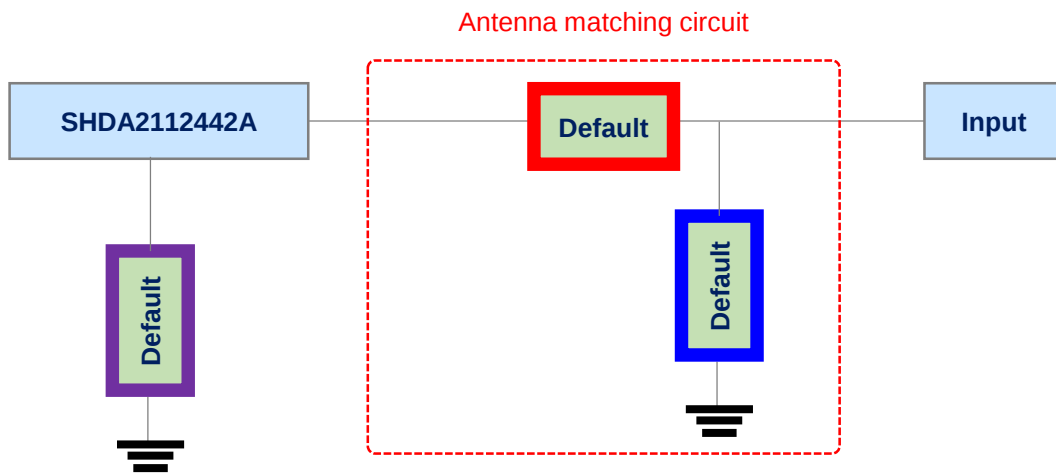


1-4. Radiation pattern



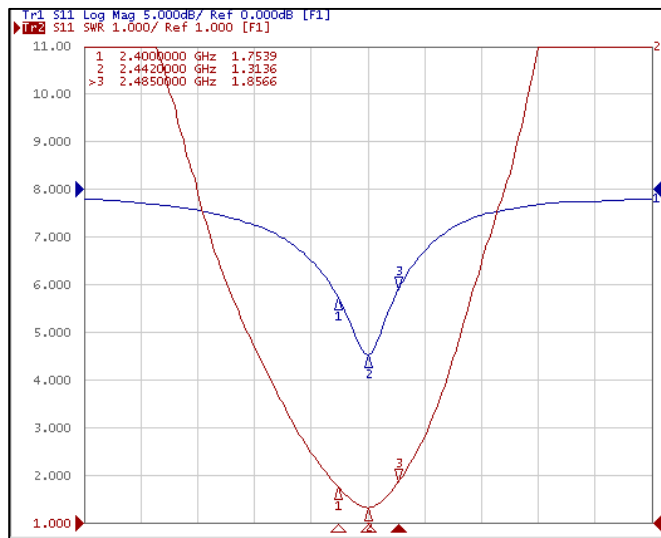
2. Measurement Report – Default on Hand phantom

2-1. Antenna matching value



Set condition

2-2. Measured S-parameter

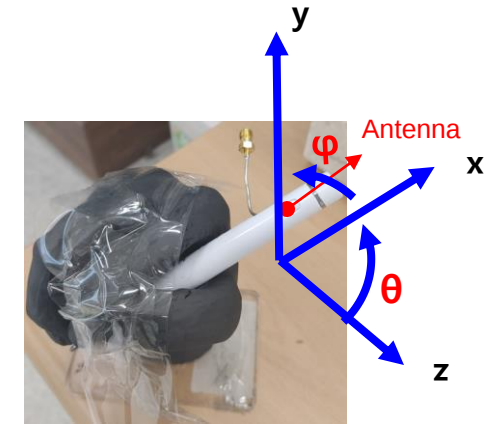


Return Loss & VSWR

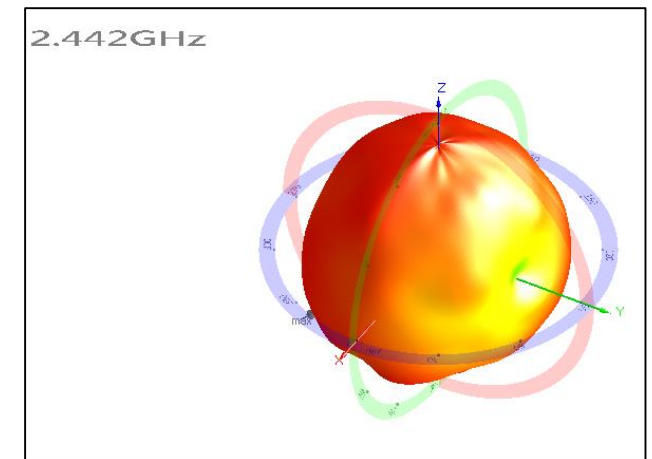
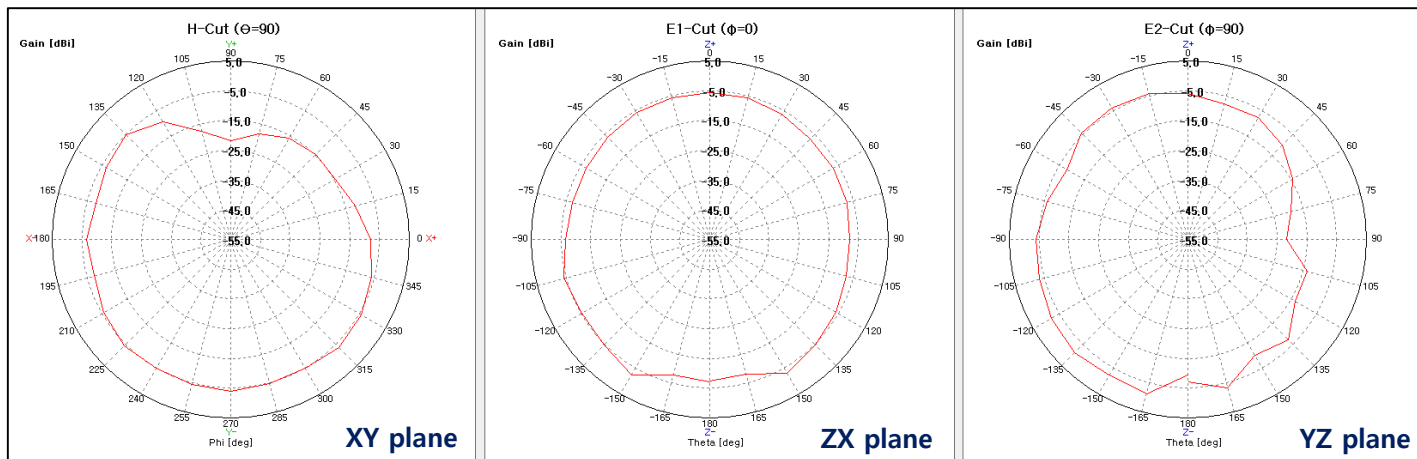
2. Measurement Report – Default on Hand phantom

2-3. Antenna gain

Frequency [MHz]	Efficiency [%]	Average gain [dBi]	Peak gain [dBi]
2400	23.23	-6.31	-1.01
2442	28.89	-5.39	0.30
2485	22.08	-6.56	-0.73



2-4. Radiation pattern



Type	2.4GHz Chip Antenna
Application	2.4GHz
Part No.	AMAN201510ST01
Revision	0

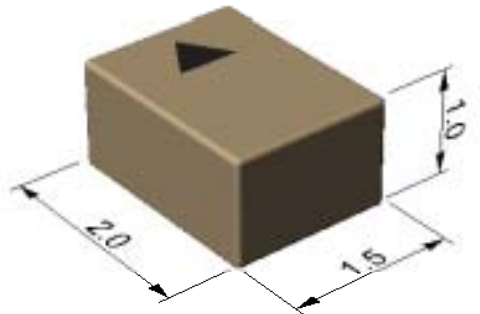
DATASHEET

Application

Bluetooth
Zigbee
WLAN (IEEE 802.11 b/g)
ISM 2.4GHz Wireless Devices

Features

PIFA Structure
Small Size ($2.0 \times 1.5 \times 1.0 \text{ mm}^3$)
Easy Optimizing
with external lumped matching components
SMT Available under Pb-free Condition
RoHS Compliant



AMOTECH

Revision History

Rev. No	Date	Title	Contents	Page
0	'09.08.27		New Published	

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1. Specifications

1.1 Electrical Specifications

No	Item	Spec.	Remark
1	Frequency Range [GHz]	2.4 ~2.485	
2	VSWR	Max 3.0:1	
3	Peak Gain [dBi]	typ. 2.9	
4	Total Avg. Gain [dBi]	typ. -0.9	
5	Efficiency [%]	typ. 82	
6	Polarization	Linear	
7	Impedance [Ω]	Nominal 50	

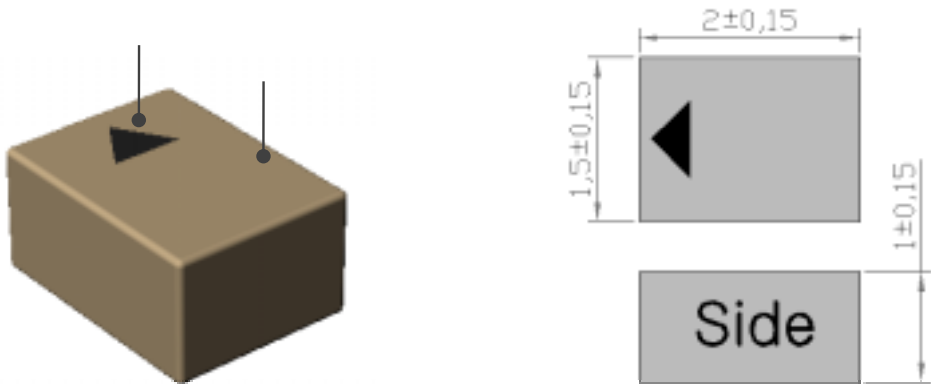
- ✓ The results are measured on the 50x50mm² evaluation board(EVB).
- ✓ See Page 6. for more detail gain parameter

1.2 Mechanical Specifications

No	Item	Spec.	Remark
1	Dimensions (LxWxH)	2.0x1.5x1.0 mm ³	
2	Unit Weight	typ. 11mg	
3	Operating Temperature	-35 ~ +85	

1.3 Appearance & Material

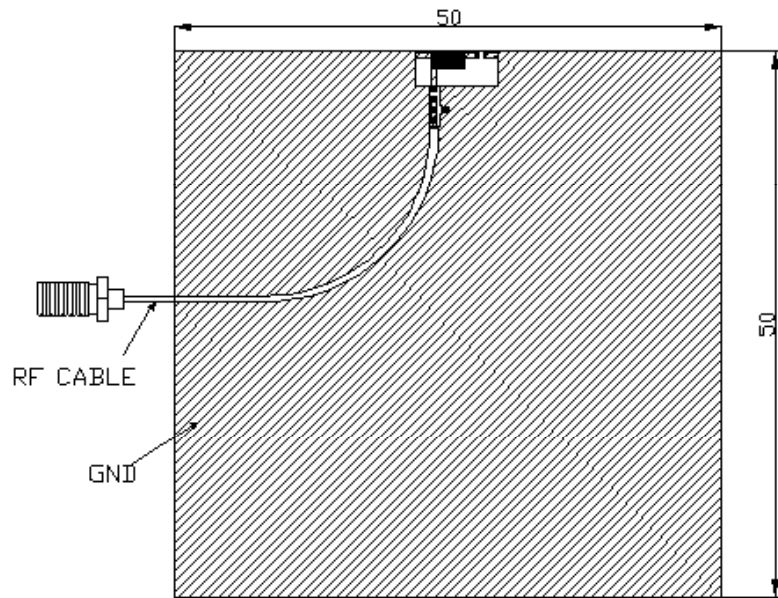
No	Item	Function	Material
	Marking	Feeding Index	Ink
	Ceramic Body	-	Ceramic



[unit : mm]

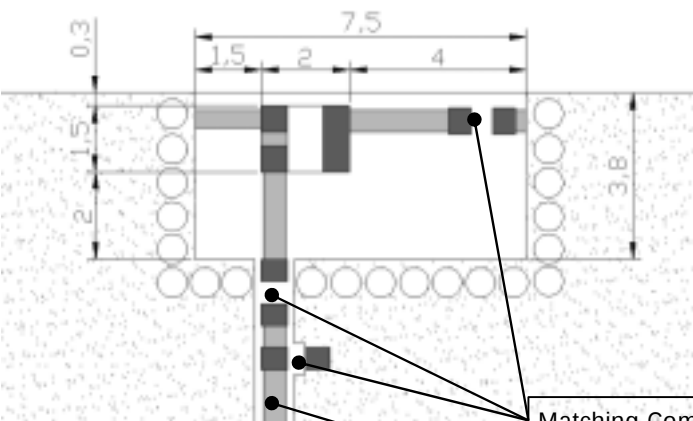
2. PCB Design for Test

2.1 Evaluation Board Dimension



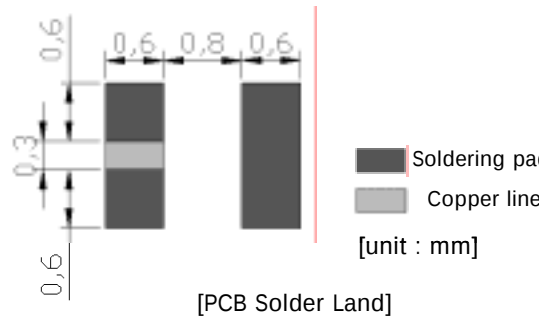
- ✓ Evaluation board size ~ 50x50
- ✓ Fill Cut Area (GND Clearance) ~ 7.5x3.8

2.2 PCB Design Guide



Matching Component

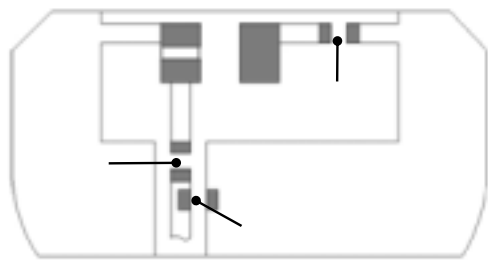
50 Ohm Feeding Line



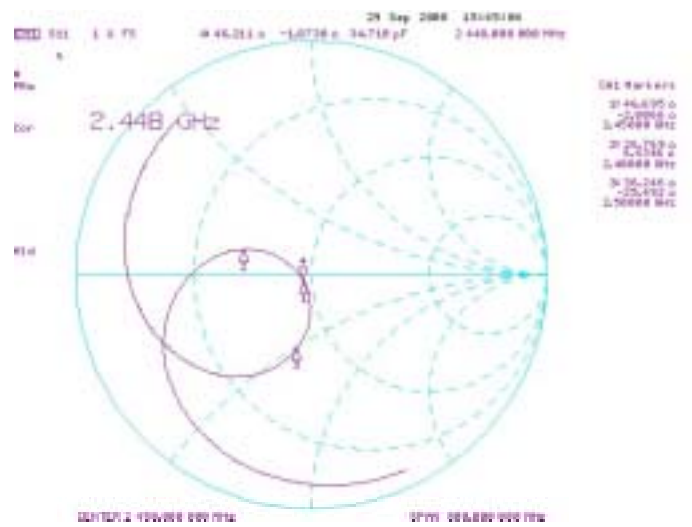
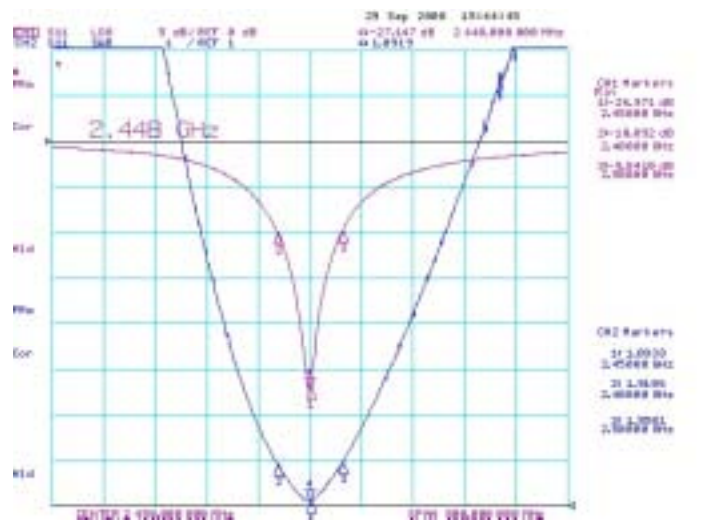
No	Pin Assignment
	Feeding
	GND
	GND

3. Measurement Result

3.1 Typical Measurement Result (VSWR/RL, Smithchart)



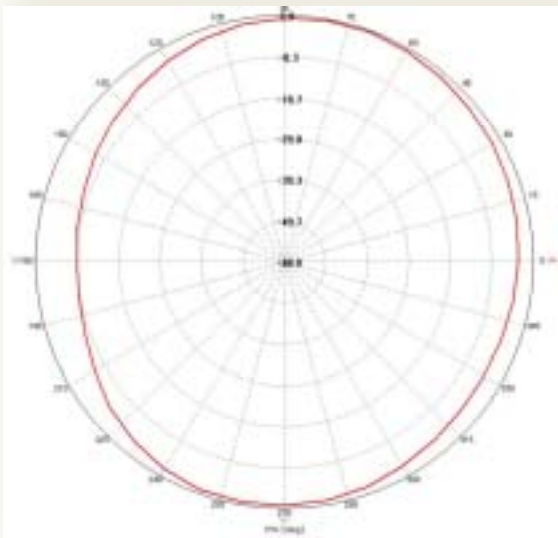
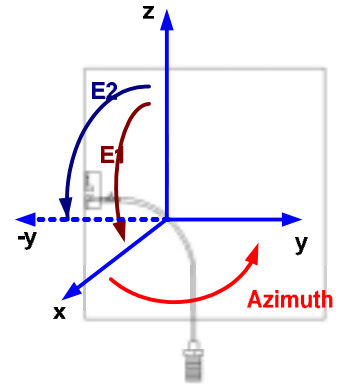
No	Matching Value
	1.2nH
	3.3pF
	2.7nH



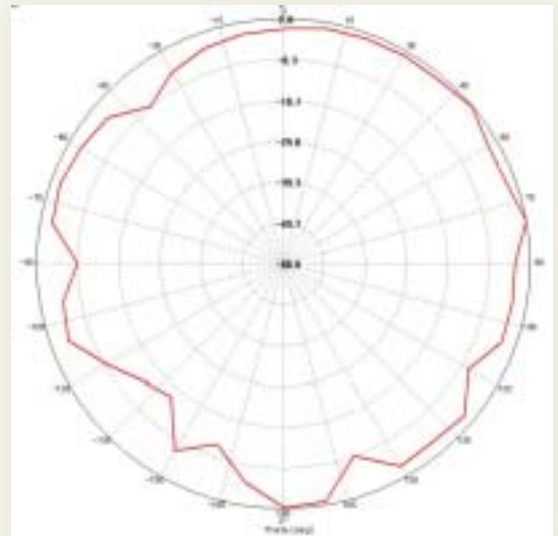
✓ The results are measured on the 50x50mm² evaluation board(EVB).

3.2 Typical Measurement Result (Gain, Radiation Pattern)

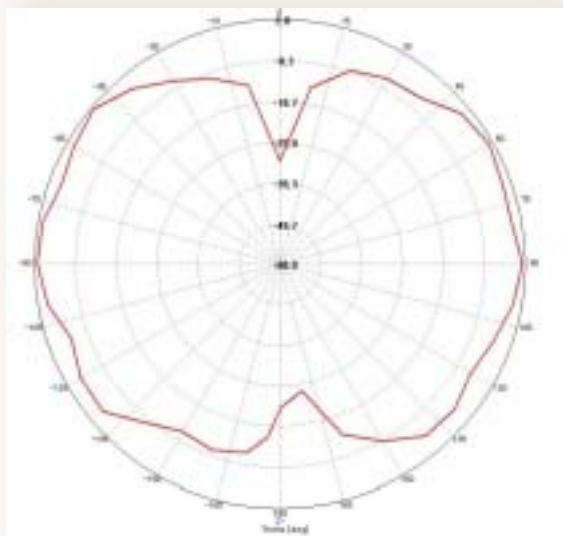
	Peak Gain (dBi)	Avg. Gain (dBi)	Total Avg. Gain (dBi)	Efficiency (%)
Azimuth	1.63	-1.23	-0.85	82
Elevation 1	2.32	-1.58		
Elevation 2	1.36	-2.75		



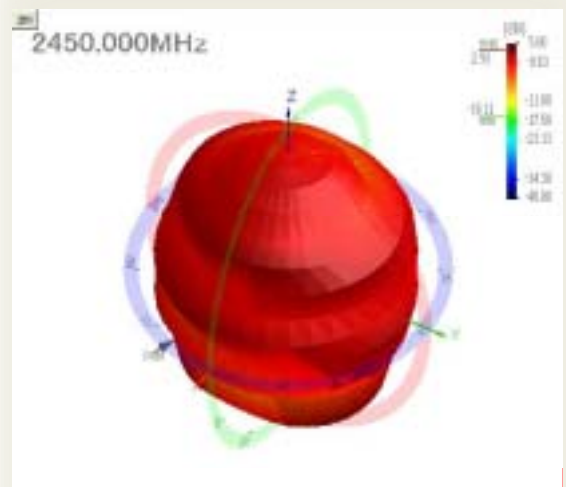
[Azimuth plane @2.45GHz]



[Elevation1 plane @2.45GHz]

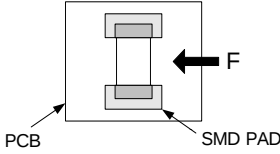


[Elevation2 plane @2.45GHz]

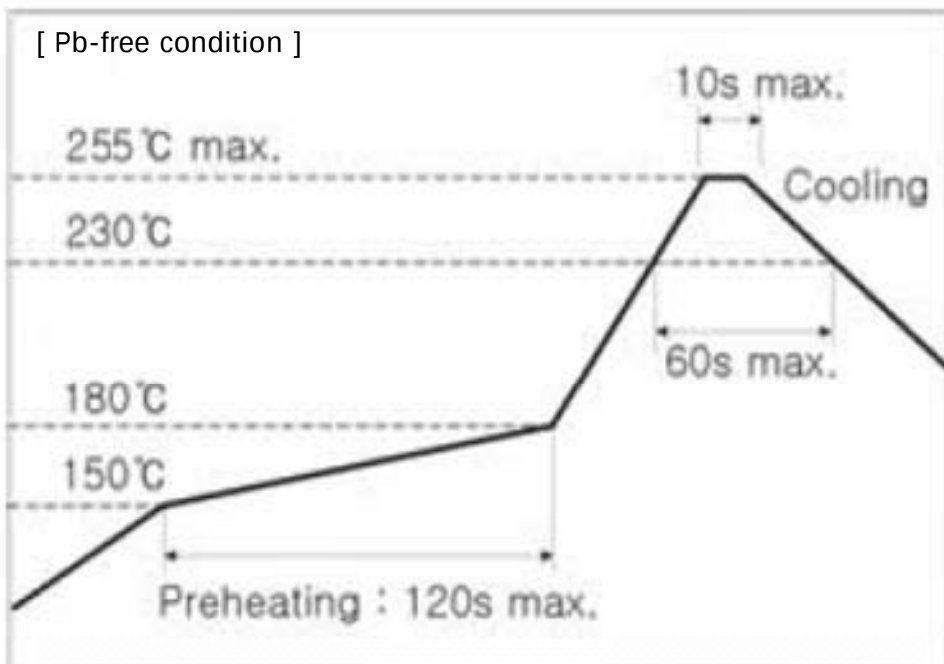


[3D Radiation Pattern]

4. Reliability

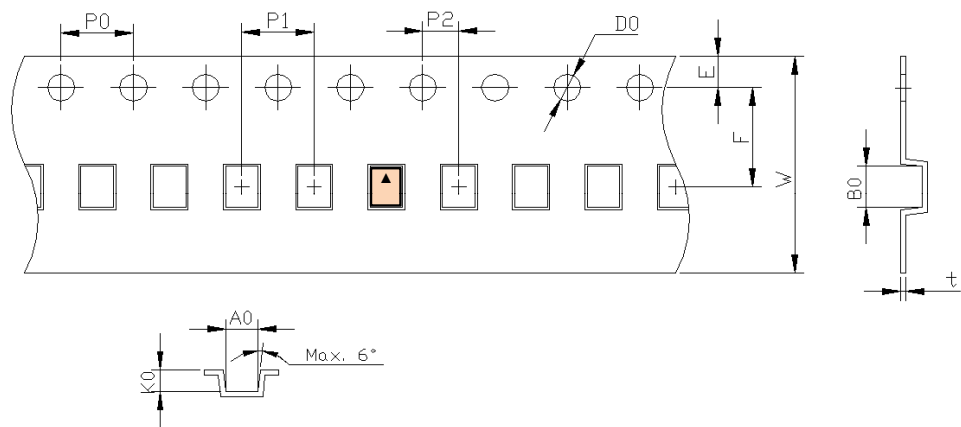
No	Item	Test Condition	Test Requirements
1	Adhesive Strength of Termination	1. Applied force on SMT chip till detached point from PCB. 	1. No mechanical damage by applied force 2. Strength (F) > 1 kgf
2	Thermal Shock (Cycle)	1. Step 1 : -40 ± 3 , 30 min Step 2 : $+125 \pm 3$, 30 min 2. Number of cycle : 30	1. No visual damage 2. Within electric spec (VSWR)
3	High Temperature Resistance	1. Temperature : $+125 \pm 5$ 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)
4	Low Temperature Resistance	1. Temperature : -40 ± 5 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)
5	Humidity	1. Humidity : 85 % RH Temperature : $+85 \pm 3$ 2. Time : 1000 ± 24 hrs	1. No visual damage 2. Within electric spec (VSWR)

5. Soldering Reflow Profile



6. Packaging

6.1 Carrier Tape Dimension



Item	Spec.	Item	Spec.	Item	Spec.
A0	1.80 ±0.10	P0	4.00 ±0.10	E	1.75 ±0.10
B0	2.30 ±0.10	P1	4.00 ±0.10	F	5.50 ±0.10
K0	1.20 ±0.10	P2	2.00 ±0.10	W	12.00 ±0.30
D0	1.55 ±0.05	-	-	t	0.30 ±0.10

6.2 Packaging Label

AMOTECH Co., Ltd.

5BL-1Lot, 617, Namchon-Dong, Namdong-Gu, Incheon, Korea

Dielectric Chip Antenna

P/N : AMAN201510ST01

Lot No :

Quantity : 2,500 pcs Date : 2009/08/27